

8-Channel Analog Multiplexer with Cascadable Serial Interface

FEATURES

- Low R_{ON} : 45 Ω
- Single 2.7V to ±5V Supply Operation
- Low Charge Injection
- Serial Digital Interface
- Analog Inputs May Extend to Supply Rails
- Low Leakage: ±5nA Max
- Guaranteed Break-Before-Make
- TTL/CMOS Compatible for All Digital Inputs
- Cascadable to Allow Additional Channels
- Can Be Used as a Demultiplexer

APPLICATIONS

- Data Acquisition Systems
- Communication Systems
- Signal Multiplexing/Demultiplexing

DESCRIPTION

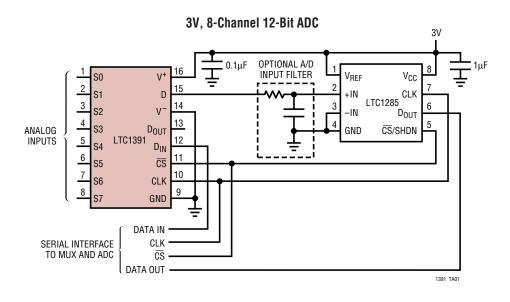
The LTC $^{\circ}$ 1391 is a high performance CMOS 8-to-1 analog multiplexer. It features a serial digital interface that allows several LTC1391s to be daisy-chained together, increasing the number of MUX channels available using a single digital port.

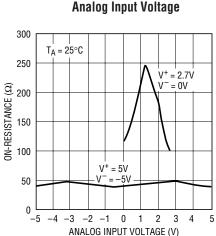
The LTC1391 features a typical R_{ON} of 45Ω , a typical switch leakage of 50pA and guaranteed break-before-make operation. Charge injection is ± 10 pC maximum. All digital inputs are TTL and CMOS compatible when operated from single or dual supplies. The inputs can withstand 100mA fault current.

The LTC1391 is available in 16-pin PDIP, SSOP and narrow SO packages. For applications requiring 2-way serial data transmission, see the LTC1390 data sheet.

17, LTC and LT are registered trademarks of Linear Technology Corporation.

TYPICAL APPLICATION





On-Resistance vs

ABSOLUTE MAXIMUM RATINGS

(Note 1)
Total Supply Voltage (V+ to V-)
Input Voltage
Analog Inputs/Outputs $(V^ 0.3V)$ to $(V^+ + 0.3V)$
Digital Inputs0.3V to 15V
Digital Outputs $-0.3V$ to $(V^+ + 0.3V)$
Power Dissipation 500mW
Operating Temperature Range
LTC1391C0°C to 70°C
LTC1391I40°C to 85°C
Storage Temperature Range65°C to 150°C
Lead Temperature (Soldering, 10 sec)

PACKAGE/ORDER INFORMATION

SO 1	16 V ⁺	ORDER PART NUMBER
S1 2 S2 3 S3 4 S4 5 S5 6 S6 7 S7 8	15 D 14 V ⁻ 13 D _{OUT} 12 D _{IN} 11 CS 10 CLK 9 GND	LTC1391CGN LTC1391CN LTC1391CS LTC1391IGN LTC1391IN LTC1391IS
GN PACKAGE N 16-LEAD PLASTIC SSOP 16-	GN PART MARKING	
S PACKAGE 16-LEAD PLASTIC T _{JMAX} = 125°C, θ _{JA} = 110° T _{JMAX} = 125°C, θ _{JA} = 70°C T _{JMAX} = 125°C, θ _{JA} = 100°	1391 1391I	

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25 \,^{\circ}$ C. $V^+ = 5V$, $V^- = -5V$, GND = 0V, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS
Switch								
V _{ANALOG}	Analog Signal Range	(Note 2)		•	-5		5	V
R _{ON}	On-Resistance	$V_S = \pm 3.5 V$, $I_D = 1 mA$	T _{MIN} = 0°C (LTC1391C) T _{MIN} = -40°C (LTC1391I)				75	Ω
			25°C			45	75	Ω
			T _{MAX} = 70°C (LTC1391C) T _{MAX} = 85°C (LTC1391I)				120	Ω
	ΔR _{ON} vs V _S					20		%
	ΔR _{ON} vs Temperature					0.5		%/°C
I _{S(OFF)}	Off Input Leakage	$V_S = 4V$, $V_D = -4V$, $V_S = -4V$, $V_D = 4V$ Channel Off		•		±0.05	±5 ±20	nA nA
I _{D(OFF)}	Off Output Leakage	$V_S = 4V$, $V_D = -4V$, $V_S = -4V$, $V_D = 4V$ Channel Off		•		±0.05	±5 ±20	nA nA
I _{D(ON)}	On Channel Leakage	$V_S = V_D = \pm 4V$ Channel On		•		±0.05	±5 ±20	nA nA
Digital								
V _{INH}	High Level Input Voltage	V ⁺ = 5.25V		•	2.4			V
V _{INL}	Low Level Input Voltage	V+ = 4.75V		•			0.8	V
I _{INL} , I _{INH}	Input Current	V _{IN} = 5V, 0V		•			±5	μΑ
V _{OH}	High Level Output Voltage	$V^{+} = 4.75V$, $I_{0} = -10\mu A$				4.74		V
		$V^+ = 4.75V$, $I_0 = -360\mu A$		•	2.4	4.50		V
V _{OL}	Low Level Output Voltage	$V^+ = 4.75V, I_0 = 1.6mA$		•		0.5	0.8	V

LINEAR TECHNOLOGY

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $V^+ = 5V$, $V^- = -5V$, GND = 0V, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Dynamic							
f _{CLK}	Clock Frequency	(Note 2)				5	MHz
t _{ON}	Enable Turn-On Time	$V_S = 2.5V, R_L = 1k, C_L = 35pF$			260	400	ns
t _{OFF}	Enable Turn-Off Time	$V_S = 2.5V, R_L = 1k, C_L = 35pF$			100	200	ns
t _{OPEN}	Break-Before-Make Interval			35	155		ns
OIRR	Off Isolation	$V_S = 2V_{P-P}, R_L = 1k, f = 100kHz$			70		dB
Q _{INJ}	Charge Injection	$R_S = 0$, $C_L = 1000pF$, $V_S = 1V$ (Note 2)			±2	±10	рС
C _{S(OFF)}	Input Off Capacitance				5		pF
C _{D(0FF)}	Output Off Capacitance				10		pF
Supply							
[+	Positive Supply Current	All Logic Inputs Tied Together, V _{IN} = 0V or 5V	•		15	40	μΑ
I-	Negative Supply Current	All Logic Inputs Tied Together, V _{IN} = 0V or 5V	•		-15	-40	μΑ

The ullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $V^+ = 2.7V$, $V^- = GND = 0V$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS			MIN	TYP	MAX	UNITS
Switch								
V _{ANALOG}	Analog Signal Range	(Note 2)		•	0		2.7	V
R _{ON}	On-Resistance	V _S = 1.2V, I ₀ = 1mA	T _{MIN} = 0°C (LTC1391C) T _{MIN} = -40°C (LTC1391I)				300	Ω
			25°C			250	300	Ω
			T _{MAX} = 70°C (LTC1391C) T _{MAX} = 85°C (LTC1391I)				350	Ω
	ΔR _{ON} vs V _S					20		%
	ΔR _{ON} vs Temperature					0.5		%/°C
I _{S(OFF)}	Off Input Leakage	$V_S = 2.5V, V_D = 0.5V; V_S = 0.5V, V_D = 2.5V \text{ (Note 3)}$ Channel Off		•		±0.05	±5 ±20	nA nA
I _{D(OFF)}	Off Output Leakage	$V_S = 2.5V$, $V_D = 0.5V$; $V_S = 0.5V$, $V_D = 2.5V$ (Note 3) Channel Off		•		±0.05	±5 ±20	nA nA
I _{D(ON)}	On Channel Leakage	V _S = V _D = 0.5V, 2.5V (Note 3) Channel On		•		±0.05	±5 ±20	nA nA
Digital								
V _{INH}	High Level Input Voltage	V+ = 3.0V		•	2.0			V
V _{INL}	Low Level Input Voltage	V+ = 2.4V		•			0.8	V
I _{INL} , I _{INH}	Input Current	V _{IN} = 2.7V, 0V		•			±5	μА
V _{OH}	High Level Output Voltage	$V^{+} = 2.7V, I_{0} = -20\mu A$ $V^{+} = 2.7V, I_{0} = -400\mu A$		•	2.0	2.68 2.30		V
V_{0L}	Low Level Output Voltage	V ⁺ = 2.7V, I ₀ = 20μA V ⁺ = 2.7V, I ₀ = 400μA		•		0.01 0.20	0.8	V



ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $V^+ = 2.7V$, $V^- = GND = 0V$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Dynamic							
f _{CLK}	Clock Frequency	(Note 2)				5	MHz
t _{ON}	Enable Turn-On Time	$V_S = 1.5V, R_L = 1k, C_L = 35pF (Note 4)$			490	800	ns
t _{OFF}	Enable Turn-Off Time	$V_S = 1.5V, R_L = 1k, C_L = 35pF (Note 4)$			190	400	ns
t _{OPEN}	Break-Before-Make Interval	(Note 4)		125	290		ns
QIRR	Off Isolation	$V_S = 2V_{P-P}, R_L = 1k, f = 100kHz$			70		dB
Q _{INJ}	Charge Injection	$R_S = 0$, $C_L = 1000pF$, $V_S = 1V$ (Note 2)			±1	±5	pC
C _{S(OFF)}	Input Off Capacitance				5		pF
C _{D(OFF)}	Output Off Capacitance				10		pF
Supply							
I+	Positive Supply Current	All Logic Inputs Tied Together, V _{IN} = 0V or 2.7V	•		0.2	2	μА

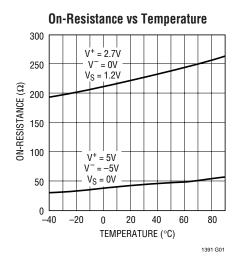
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

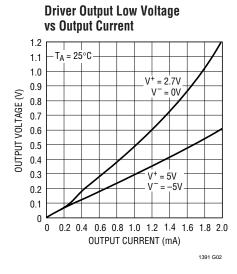
Note 2: Guaranteed by Design.

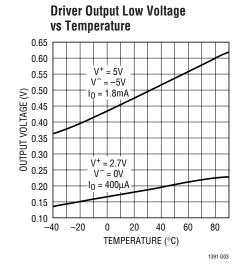
Note 3: Leakage current with a single 2.7V supply is guaranteed by correlation with the ±5V leakage current specifications.

Note 4: Timing specifications with a single 2.7V supply are guaranteed by correlation with the $\pm 5V$ timing specifications.

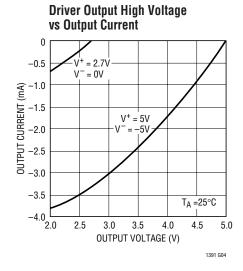
TYPICAL PERFORMANCE CHARACTERISTICS

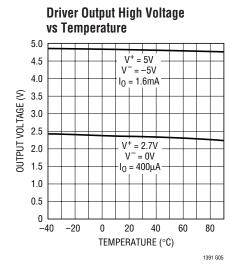






TYPICAL PERFORMANCE CHARACTERISTICS





PIN FUNCTIONS

S0, **S1**, **S2**, **S3**, **S4**, **S5**, **S6**, **S7** (**Pins 1**, **2**, **3**, **4**, **5**, **6**, **7**, **8**): Analog Multiplexer Inputs.

GND (Pin 9): Digital Ground. Connect to system ground.

CLK (Pin 10): System Clock (TTL/CMOS Compatible). The clock synchronizes the channel selection bits and the serial data transfer from D_{IN} to D_{OLIT} .

 $\overline{\text{CS}}$ (Pin 11): Channel Select Input (TTL/CMOS Compatible). A logic high on this input enables the LTC1391 to read in the channel selection bits and allows digital data transfer from D_{IN} to D_{OUT}. A logic low on this input puts D_{OUT} into three-state and enables the selected channel for analog signal transmission.

D_{IN} (**Pin 12**): Digital Input (TTL/CMOS Compatible). Input for the channel selection bits.

D_{OUT} (**Pin 13**): Digital Output (TTL/CMOS Compatible). Output from the internal shift register.

V⁻ (**Pin 14**): Negative Supply. For ± 5 V dual supply applications, $|V^-|$ should not exceed $|V^+|$ by more than 20% for proper channel selection.

D (Pin 15): Analog Multiplexer Output.

V+ (Pin 16): Positive Supply.



APPLICATIONS INFORMATION

Multiplexer Operation

Figure 1 shows the block diagram of the components within the LTC1391 required for MUX operation. The LTC1391 uses \underline{D}_{IN} to select the active channel and the chip select input, \overline{CS} , to switch on the selected channel as shown in Figure 2.

When \overline{CS} is high, the input data on the D_{IN} pin is latched into the 4-bit shift register on the rising clock edge. The input data consists of the "EN" bit and a string of three bits for channel selection. If "EN" bit is logic high as illustrated in the first input data sequence, it enables the selected channel. After the clocking in of the last channel selection bit B0, the \overline{CS} pin must be pulled low before the next rising clock edge to ensure correct operation. Once \overline{CS} is pulled low, the previously selected channel is switched off to ensure a break-before-make interval. After a delay of t_{ON} , the selected channel is switched on allowing signal transmission. The selected channel remains on until the next falling edge of \overline{CS} . After a delay of t_{OFF} , the LTC1391 terminates the analog signal transmission and allows the

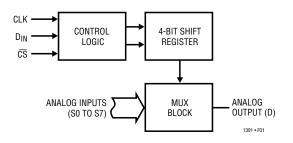


Figure 1. Simplified Block Diagram of the MUX Operation

selection of next channel. If the "EN" bit is logic low, as illustrated in the second data sequence, it disables all channels and there will be no analog signal transmission. Table 1 shows the various bit combinations for channel selection.

Table 1. Logic Table for Channel Selection

ACTIVE CHANNEL	EN	B2	B1	ВО
All Off	0	Х	Х	Х
S0	1	0	0	0
S1	1	0	0	1
S2	1	0	1	0
S3	1	0	1	1
S4	1	1	0	0
S5	1	1	0	1
S6	1	1	1	0
S 7	1	1	1	1

Digital Data Transfer Operation

The block diagram of Figure 3 shows the components within the LTC1391 required for serial data transfer. When \overline{CS} is held high, data is fed into the 4-bit shift register and then shifted to D_{OUT} . Data appears at D_{OUT} after the fourth rising edge of the clock as shown in Figure 4. The last four

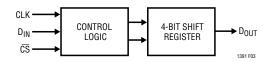


Figure 3. Simplified Block Diagram of the Digital Data Transfer Operation

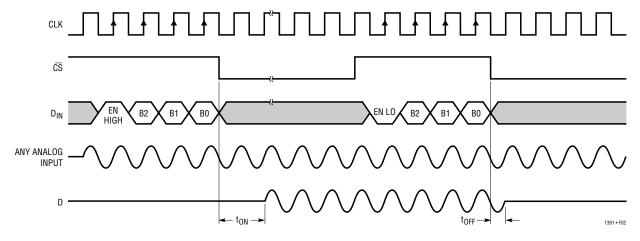


Figure 2. Multiplexer Operation



APPLICATIONS INFORMATION

bits clocked into the LTC1391 shift register before \overline{CS} is taken low select the MUX channel that is turned on. This allows a series of devices, with the D_{OUT} of one device connected to the D_{IN} of the next device, to be programmed with a single data stream.

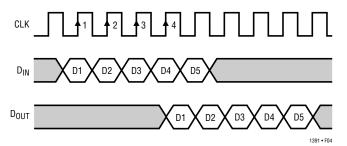


Figure 4. Digital Data Transfer Operation

Multiplexer Expansion

Several LTC1391s can be daisy-chained to expand the number of multiplexer inputs. No additional interface ports are required for the expansion. Figure 5 shows two LTC1391s connected at their analog outputs to form a 16-to-1 multiplexer at the input to an LTC1400 A/D converter.

To ensure that only one channel is switched on at any one time, two sets of channel selection bits are needed for DATA as shown in Figure 6. The first data sequence is used to switch off one MUX and the second data sequence is used to select one channel from the other MUX or vice versa. In other words, if bit "ENA" is high and bit "ENB" is low, one channel of MUX A is switched on and all channels of MUX B are switched off. If bit "ENA" is low and bit "ENB" is high, all channels at MUX A are switched off and one channel of MUX B is switched on. Care should be taken to ensure that only one LTC1391 is enabled at any one time to prevent two channels from being enabled simultaneously.

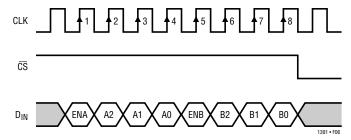


Figure 6. Data Sequence for MUX Expansion

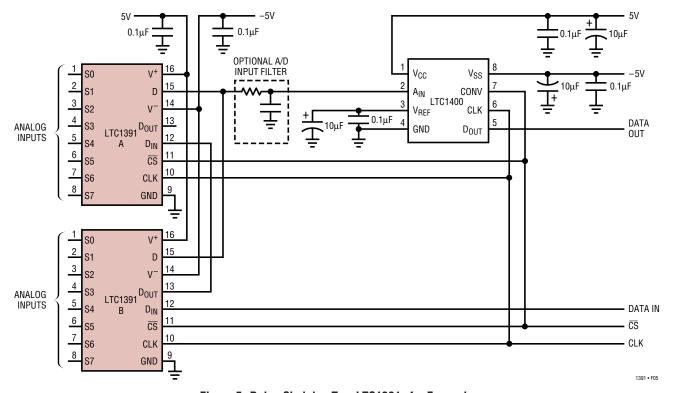
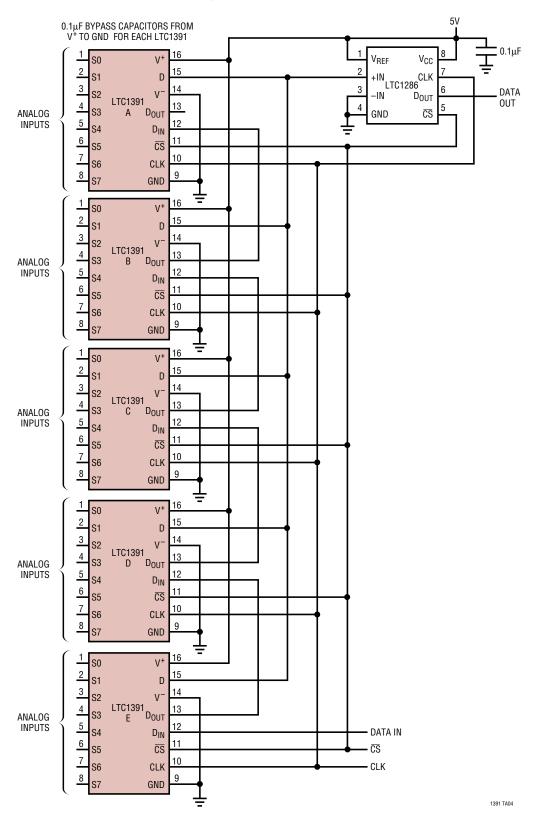


Figure 5. Daisy-Chaining Two LTC1391s for Expansion



TYPICAL APPLICATIONS

Daisy-Chaining Five LTC1391s

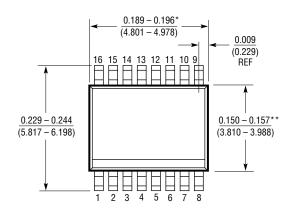


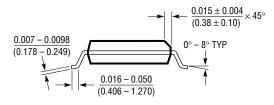
/ LINEAR

PACKAGE DESCRIPTION

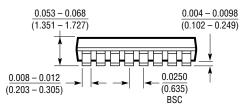
GN Package 16-Lead Plastic SSOP (Narrow .150 Inch)

(Reference LTC DWG # 05-08-1641)





- * DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE
- ** DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



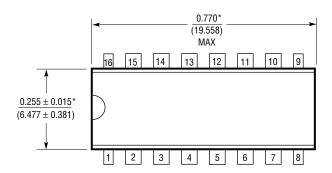
GN16 (SSOP) 1098

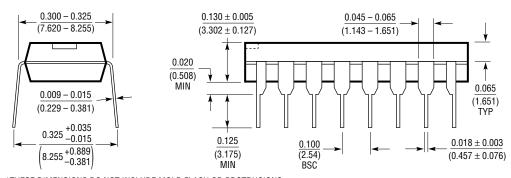


PACKAGE DESCRIPTION

N Package 16-Lead PDIP (Narrow .300 Inch)

(Reference LTC DWG # 05-08-1510)



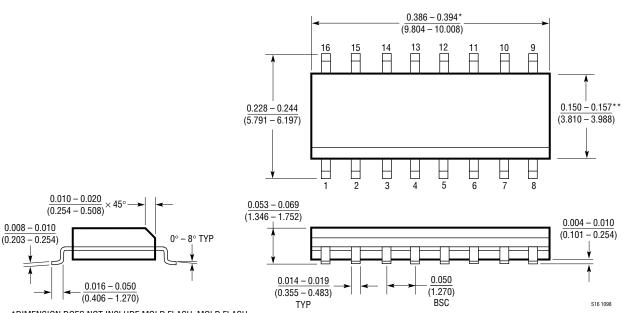


*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

N16 1098

PACKAGE DESCRIPTION

S Package 16-Lead Plastic Small Outline (Narrow .150 Inch) (Reference LTC DWG # 05-08-1610)

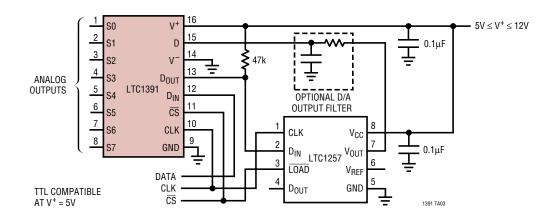


^{*}DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

^{**}DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

TYPICAL APPLICATION

Interfacing LTC1391 with LTC1257 for Demultiplex Operation



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1285	3V 12-Bit ADC	Micropower, Auto Shutdown, SO-8 Package, SPI, QSPI + MICROWIRE™Compatible
LTC1286	5V 12-Bit ADC	Micropower, Auto Shutdown, SO-8 Package, SPI, QSPI + MICROWIRE Compatible
LTC1380/LTC1393	SMBus-Controlled Analog Multiplexer	Low R _{ON} and Low Charge Injection
LTC1390	Serial-Controlled 8-to-1 Analog Multiplexer	Low R _{ON} , Bidirectional Serial Interface, Low Power, 16-Pin SO
LTC1401	3V, 12-Bit, 200ksps Serial ADC	15mW, Internal Reference, SO-8 Package
LTC1402	12-Bit, 2.2Msps Serial ADC	90mW with Nap and Sleep Modes, 5V or ±5V, Internal Reference
LTC1404	12-Bit, 600ksps Serial ADC	5V or ±5V, Internal Reference and Shutdown
LTC1417	14-Bit, 400ksps Serial ADC	20mW, Single 5V or ±5V Supply
LTC1451	5V 12-Bit Voltage Output DAC	Complete V _{OUT} DAC, SO-8 Package, Daisy-Chainable, Low Power
LTC1452	5V and 3V 12-Bit Voltage Output DAC	Multiplying V _{OUT} DAC, SO-8 Package, Rail-to-Rail Output, Low Power
LTC1453	3V 12-Bit Voltage Output DAC	Complete V _{OUT} DAC, SO-8 Package, Daisy-Chainable, Low Power
LT1460-2.5	Micropower, Precision Bandgap Reference	130μA Supply Current, 10ppm/°C, Available in SOT-23
LT1461-2.5	Micropower, Low Dropout Reference	50μA Supply Current, 300mV Dropout, 3ppm/°C Drift
LTC1655/LTC1655L	16-Bit, Voltage Output DAC, 5V/3V	SO-8 Package, Micropower, Serial I/O
LTC1658	14-Bit, Voltage Output DAC	Micropower, Multiplying V _{OUT} , Swings from GND to V _{REF}

MICROWIRE is a trademark of National Semiconductor.

LT/TP 0701 1.5K REV A • PRINTED IN USA

TECHNOLOGY

© LINEAR TECHNOLOGY CORPORATION 1995

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Multiplexer Switch ICs category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

NLV74HC4066ADR2G HEF4051BP MC74HC4067ADTG DG508AAK/883B NLV14051BDG 016400E PI3V512QE 7705201EC
PI2SSD3212NCE NLAS3257CMX2TCG PI3DBS12412AZLEX PI3V512QEX PI3DBS16213ZLEX PI3DBS16415ZHEX
MUX36S16IRSNR 74LVC1G3157GM-Q10X TC7W53FK,LF CD4053BM96 MC74HC4053ADWR2G SN74LV4051APWR
HEF4053BT.653 ADG5408BRUZ-REEL7 ADG1404YRUZ-REEL7 ADG1208YRZ-REEL7 MAX4704EUB+T ADG1406BRUZ-REEL7
LTC4305IDHD#PBF CD4053BPWRG4 74HC4053D.653 74LVC2G53DP.125 74HC4052DB.112 74HC4052PW.112 74HC4053DB.112
74HC4067DB.112 74HC4351DB.112 74HCT4052D.112 74HCT4052DB.112 74HCT4053DB.112 74HCT4067D.112 74HCT4351D.112
74LV4051PW.112 FSA1256L8X_F113 PI5V330QE PI5V331QE 5962-8771601EA 5962-87716022A ADG5249FBRUZ ADG1438BRUZ
AD7506JNZ AD7506KNZ